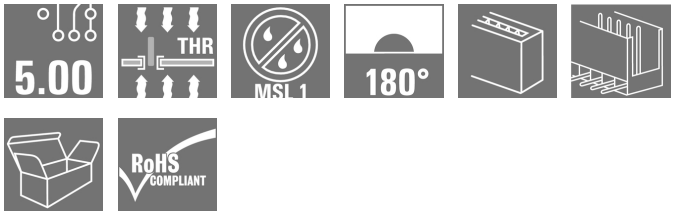
SL-SMT 5.00HC/06/180 3.2SN BK BX

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany

www.weidmueller.com

Product image



High-temperature-resistant, straight, open pin header. Packed in box or tape. On tape and with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, open side, THT/THR solder connection, 5.00 mm, Number of poles: 6, 180°, Solder pin length (l): 3.2 mm, tinned, black, Box
Order No.	1840960000
Type	SL-SMT 5.00HC/06/180 3.2SN BK BX
GTIN (EAN)	4032248351855
Qty.	50 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Box

Creation date March 25, 2021 5:11:56 PM CET

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Technical data

Dimensions and weights

Depth	8.5 mm	Depth (inches)	0.335 inch
Height	15.2 mm	Height (inches)	0.598 inch
Height of lowest version	12 mm	Net weight	2.62 g
Width	30 mm	Width (inches)	1.181 inch

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.00	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	180°
Number of poles	6	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin length tolerance	+0.1 / -0.2 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder pin dimensions = d tolerance	0 / -0,03 mm
Solder eyelet hole diameter (D)	1.4 mm	Solder eyelet hole diameter tolerance (D)	+ 0,1 mm
L1 in mm	25 mm	L1 in inches	0.984 inch
Number of rows	1	Pin series quantity	1
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	7 N	Pulling force/pole, max.	5.5 N

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuMg
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	27.5 A
Rated current, max. number of poles (Tu=20°C)	19 A	Rated current, min. number of poles (Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		

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Technical data

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	200039-1176845
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	15 A	Rated current (Use group D / CSA)	15 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Rated data acc. to UL 1059

Institute (UR)		Certificate No. (UR)	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	18.5 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packing

Packaging	Box	VPE length	42 mm
VPE width	70 mm	VPE height	168 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Gold-plated contact surfaces on request • Rated current related to rated cross-section & min. No. of poles. • Diameter of solder eyelet D = 1.4+0.1mm • Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

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Technical data

Approvals

Approvals	
ROHS	Conform
UL File Number Search	E60693

Downloads

Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Engineering Data	STEP

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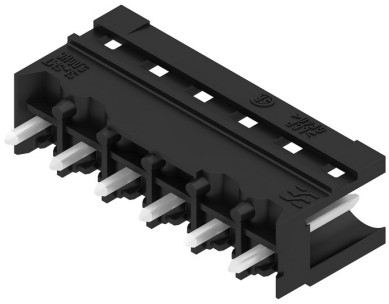
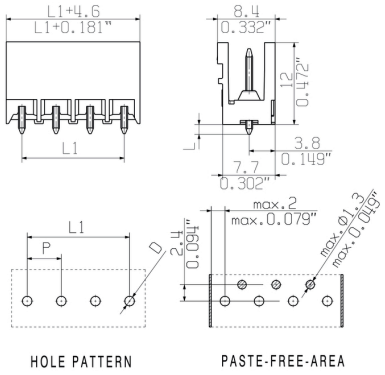
Drawings

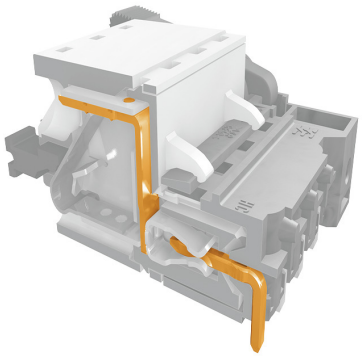
Product image



Dimensional drawing



Product benefits



Safe power transmission
Proven properties

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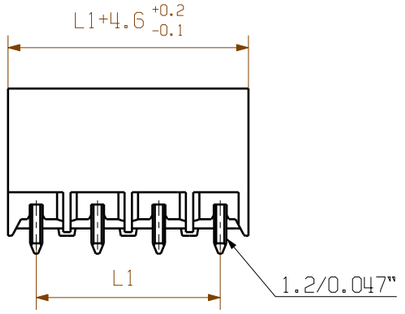
Drawings

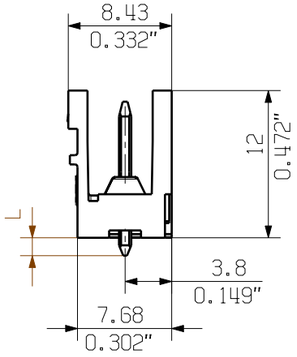
Product benefits

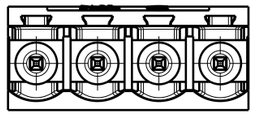
Compliant with existing standards

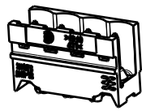
Dimensions without tolerances are no check dimensions

The English version is binding









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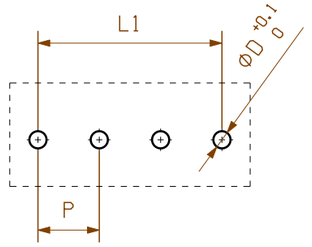
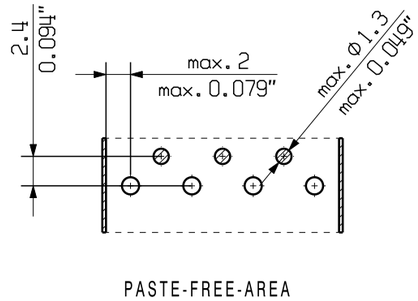


HOLE PATTERN



PASTE-FREE-AREA

24	115,00	4,528
23	110,00	4,331
22	105,00	4,134
21	100,00	3,937
20	95,00	3,740
19	90,00	3,543
18	85,00	3,346
17	80,00	3,150
16	75,00	2,953
15	70,00	2,756
14	65,00	2,559
13	60,00	2,362
12	55,00	2,165
11	50,00	1,969
10	45,00	1,772
9	40,00	1,575
8	35,00	1,378
7	30,00	1,181
6	25,00	0,984
5	20,00	0,787
4	15,00	0,591
3	10,00	0,394
2	5,00	0,197
n	L1 [mm]	L1 [Inch]

D= 1.4/0.055" or 1.5/0.059"(REFLOW SOLDERING)
RECOMMENDATION FOR AUTOMATIC ASSEMBLY
(1.4mm FOR n=2...8 / 1.5mm for n=9...24)

P=RASTER/PITCH

SHOWN: SL-SMT 5.00HC/04/180

STIFTLAENGE L	TOLERANZ
1,5	0,0
	-0,3
3,2	0,1
	-0,3

For the mounting of PCBs, it should be noted that the rated data stated here relates only to the PCB components alone.
The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.
The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application.
Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.

RoHS COMPLIANT

DIN ISO 2768-m

106340/4
30.07.18 HERTEL_S 00
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Modification

. .

Cat.no.: .

Weidmüller

C 34165 07
Drawing no. Issue no.

Sheet 01 of 04 sheets

	Date	Name
Drawn	22.01.2008	HERTEL_S
Responsible		HERTEL_S
Checked	27.08.2018	HERTEL_S
Approved		LANG_T

Scale: 2/1

Supersedes: .

SL-SMT 5.00HC/../180...
STIFTLEISTE
PIN HEADER

Product file: SL-SMT 5.00 7279

Wave Solder Profile

Recommended wave solderding profiles

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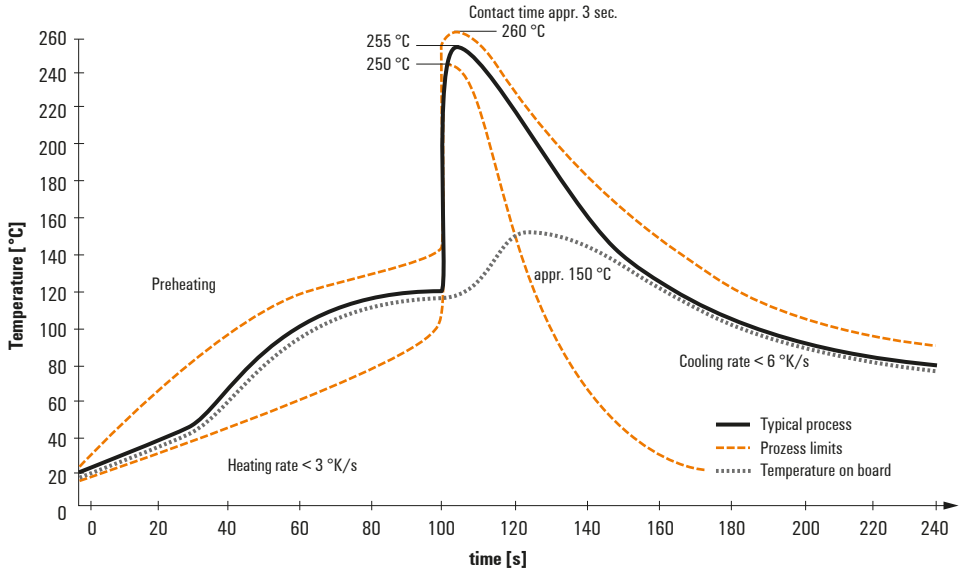
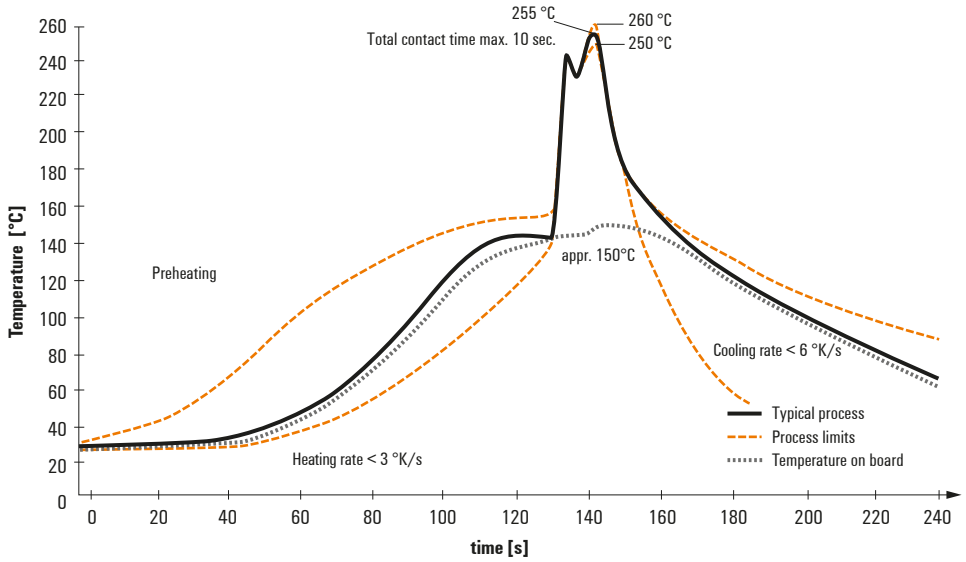
Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:
- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

Reflow Solder Profile

Recommended reflow soldering profile

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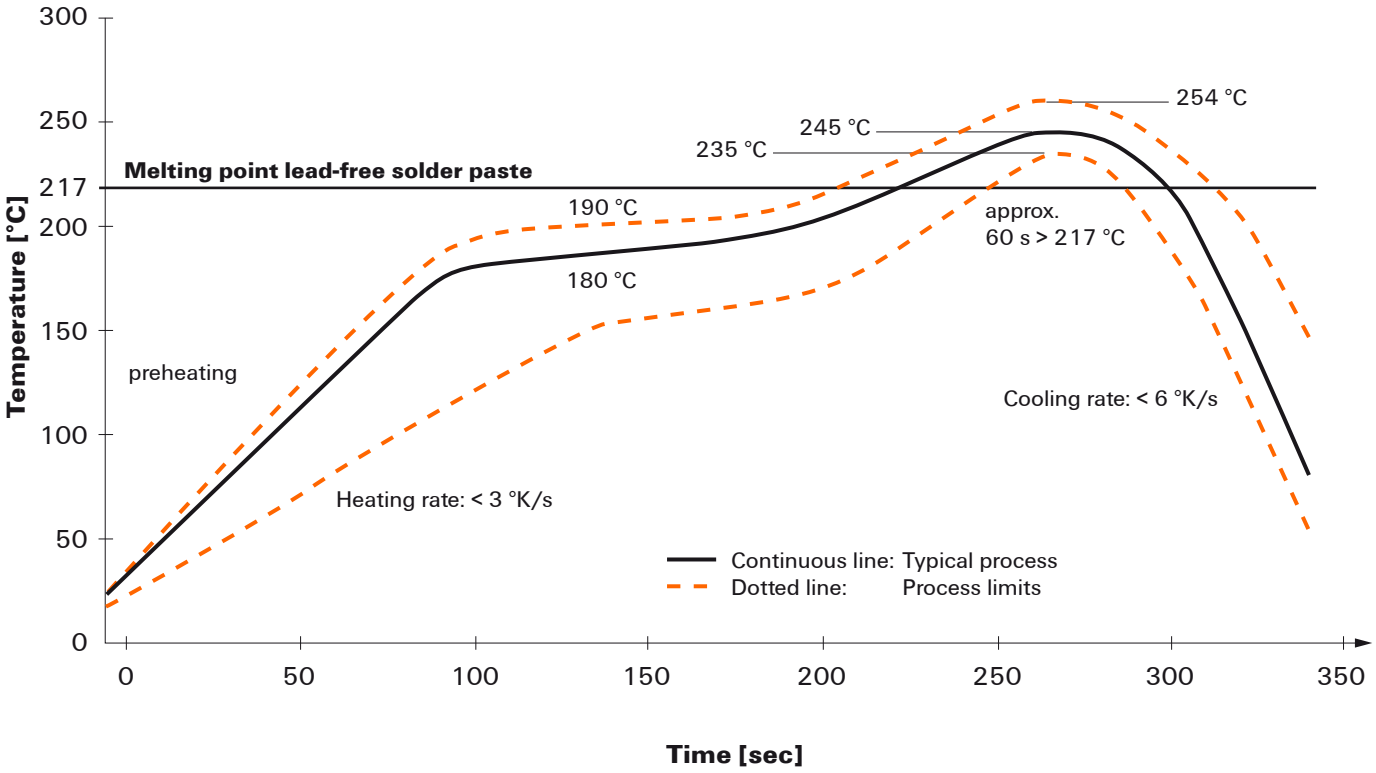

Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:
- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically ≤ +3K/s. In parallel the solder paste is ‚activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at ≥ -6K/s solder is cured. Board and components cool down while avoiding cold cracks.